TOSHIBA RF POWER AMPLIFIER MODULE

S-AV40

FM RF POWER AMPLIFIER MODULE FOR 30W COMMERCIAL VHF RADIO APPLICATIONS

・Power Gain: 34.7 dB (Min.)

・Total Efficiency: 40% (Min.)

ABSOLUTE MAXIMUM RATINGS (T_C = 25°C, I_T < 8 A, Z_G = Z_L = 50Ω)

CHARACTERISTICS	SYMBOL	TEST CONDITION	RATING	UNIT
Maximum Current	I_T		8	A
Power Supply Voltage	V_{DD}	V_{GG} = 0 V (GND), RF: none	16.5	V
Control Voltage	V_{GG}	10.5 ≤ V_{DD} ≤ 16.5 V, Pi = 50 mW	5.5	V
Instantaneous Output Power	Pomax	V_{GG} ≤ 5.5 V, Pi = 50 mW, 10.5 ≤ V_{DD} ≤ 16.5V, within 2 seconds	40	W
Input Power	P_i	10.5 ≤ V_{DD} ≤ 16.5 V, V_{GG} ≤ 5.5 V	100	mW
Operating Case Temperature	$T_{C\ (opr)}$	10.5 ≤ V_{DD} ≤ 16.5 V, V_{GG} ≤ 5.5 V, Pi = 50 mW (Note 2)	-30 to 100	°C
Storage Temperature	T_{stg}		-40 to 110	°C

Note 1: The maximum ratings are the limits that must not be exceeded even for an instant, under worst possible conditions. Exceeding the ratings may cause device damage, ignition, or deterioration. Therefore, when designing the circuitry, derating factors should be applied so that the absolute maximum ratings are not exceeded.

Note 2: The output power rating satisfies the range shown in Figures 1 and 2 according to the operating case temperature. Ensure that the device should be operated within the specified operating range. The figures below indicate the output power obtained 2 seconds after Po is generated.

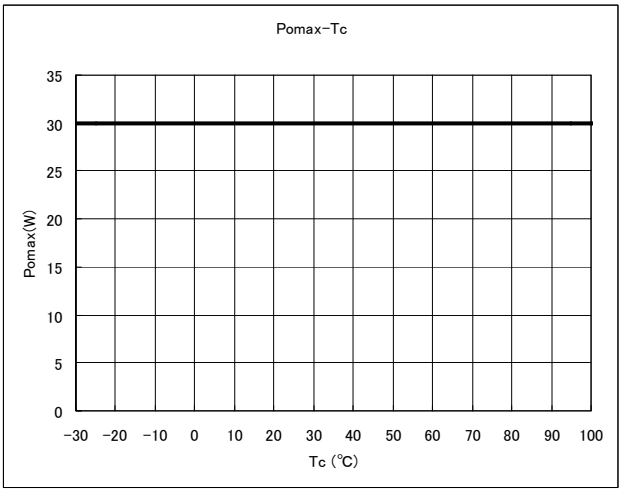


Figure 1 Pomax-Tc

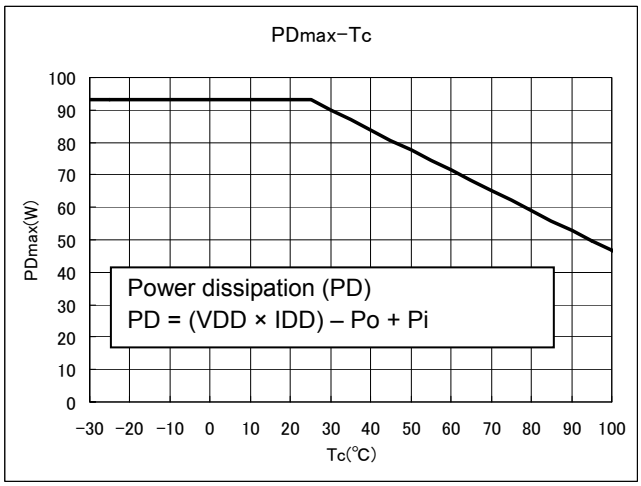


Figure 2 PDmax-Tc

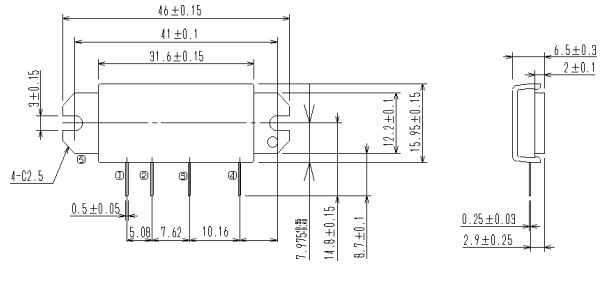
*When the device is used at Tc =100°C, the output power rating is 30 W as shown in Figure 1. When the power dissipation at Tc = 100°C exceeds the rating shown in Figure 2, the output derating is required to limit the dissipation within the specified range.

Note 3: The case temperature is monitored using the screw terminal blocks on the input side that are used for the module implementation.

Note 4: To protect a device from being permanently damaged, the power-on sequence must be as follows (, while the reversed order should be applied when turning off): 1. VDD, 2. Pi, 3. VGG

PACKAGE OUTLINE

Unit in mm



① RF Input ② V_{GG} ③ V_{DD}
④ RF Output ⑤ GROUND(FRANGE)

JEDEC	—
JEITA	—
TOSHIBA	5-32G

Weight: 11.8g

ELECTRICAL CHARACTERISTICS (Tc = 25°C, Z_G = 50Ω)

CHARACTERISTICS	SYMBOL	TEST CONDITION	MIN	TYP.	MAX	UNIT
Frequency Range	f_{range}	—	220	—	246	MHz
Output Power	P_o	V_{DD} = 12.5 V V_{GG} = 5 V Pi = 50 mW Z_L = 50 Ω	30	—	—	W
Power Gain	G_p		34.7	—	—	dB
Total Efficiency	η_T		40	—	—	%
Input VSWR	VSWRin		—	—	3.0	—
Second Harmonic	2nd HRM		—	—	-25	dB
Third Harmonic	3rd HRM		—	—	-30	dB
Ruggedness	—	10.5 V ≤ V_{DD} ≤ 16.5 V, 0 V ≤ V_{GG} ≤ V_{GGajs} (V_{GG} = V_{GGajs} @ Po = 30 W) Pi = 50 mW P_o = 30 W (Adjusted via V_{GG} @ Z_L = 50Ω) VSWR LOAD 20: 1 ALL PHASE (@ 2 s)	No Damage			—
Stability	—	10.5 V ≤ V_{DD} ≤ 16.5 V, 0 V ≤ V_{GG} ≤ V_{GGajs} (V_{GG} = V_{GGajs} @ Po = 30 W) Pi = 50 mW P_o ≤ 30 W (Adjusted via V_{GG} @ Z_L = 50Ω) VSWR LOAD 3: 1 ALL PHASE	No spurious output of -60 dB or greater			—

Note 5:The output power is intended to follow the rating provided in Figure 1 in Note 2.

Note 6: Stability

Measurements are performed under the conditions where VSWR is at 3:1 through all phases over the whole frequency range, and they are guaranteed only under those conditions. Even though it is guaranteed to be stable where VSWR is at 3:1, the VSWR load over the operating frequency should be designed to be 50 Ω. At the same time, ensure that the VSWR load does not deviate much from 50Ω even for a moment, nor deviate even a little from 50Ω continually. The S-AV40 is not intended for such operations, and proper operation under such conditions is not guaranteed due to the possibilities of heat generation in the module and its applications.

HANDLING PRECAUTIONS

- Since this product has a protective cap, care should be taken to avoid applying an excessive impact and allowing foreign objects to get inside when handling this product. Also, please do not remove a cap. If the cap is removed, the foreign object inside the module or the applied impact may lead IC failure, causing smoke or ignition.

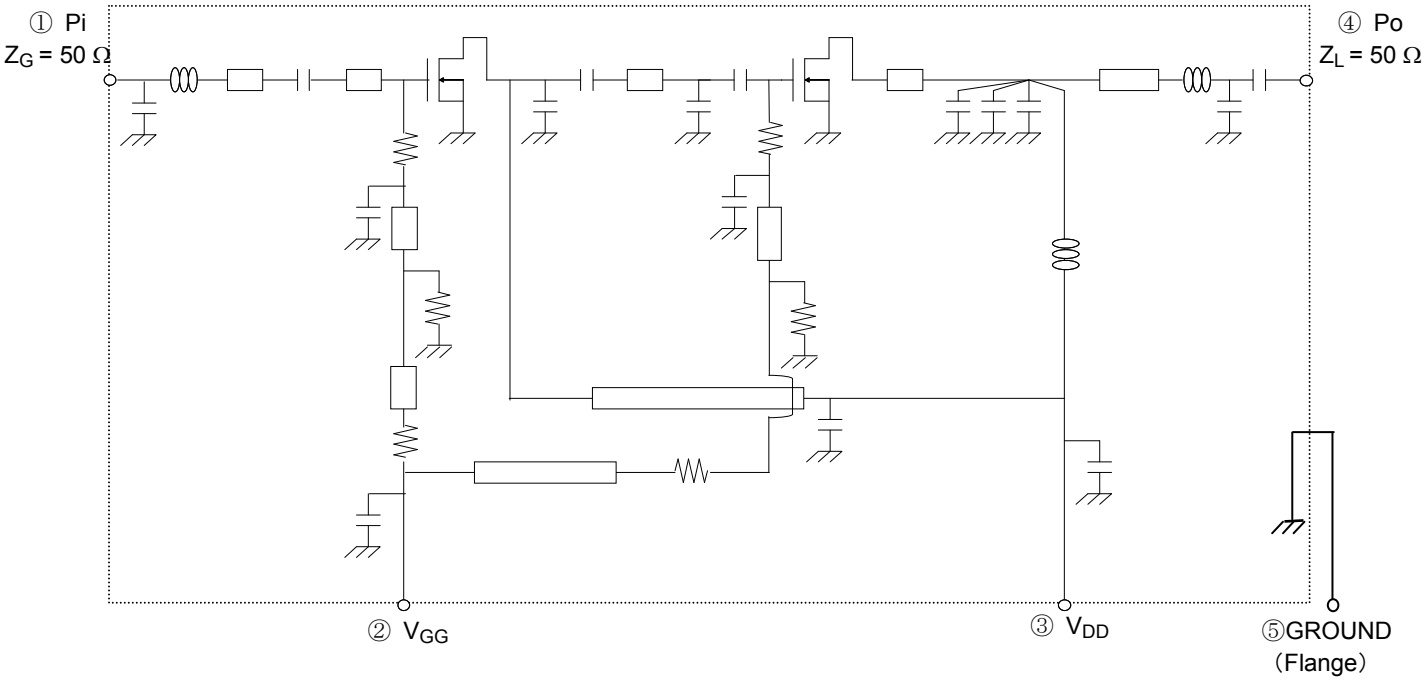
- Since this product is structurally susceptible to static electricity, protections against the static electricity should be applied to objects that may come in direct contact with devices, such as worktables, equipment, operators and solder irons.

- This product is not designed nor intended to perform a continuous transmission for applications like a base station. Please do not use this product for such applications, for the reliability cannot be guaranteed.

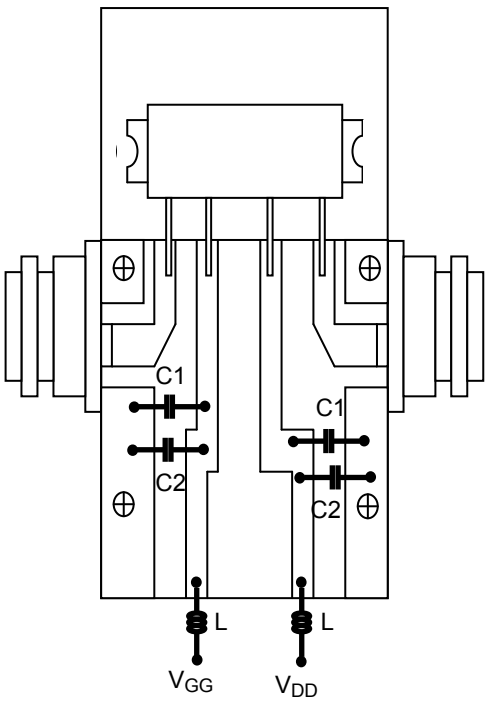
- This product is intended to be used for a single operation (single-device operation). A proper operation is not guaranteed for a parallel operation. A parallel operation should be performed in accordance with your own good judgment.

- Mounting method
  - The flatness of a heat sink must not exceed 50 μm. If the flatness exceeds 50 μm, the device may experience an unexpected stress that may lead to module breakdown due to damage or ignition in the substrate inside a module and other module parts.
  - Please apply thermal compound between a module and a heat sink to improve the adhesive property.
  - Use a 4-mm diameter screw with the clamping screw torque of 1.2 to 1.5 Nm.
  - Please solder the module leads after the screw is clamped.

EQUIVALENT CIRCUIT

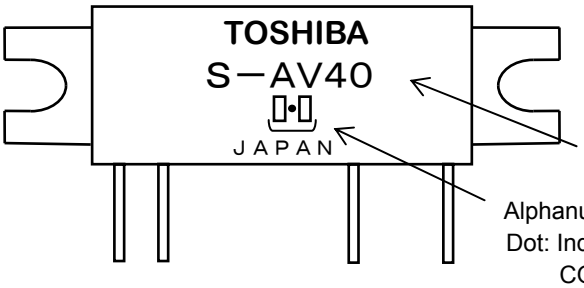


TEST FIXTURE



C1: 10000 pF
C2: 10 μF
L: φ0.5-mm enamel wire, 4T, 3ID

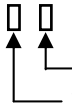
MARKING



Product Number

Alphanumeric characters: Date of manufacture
Dot: Indicates that this product is manufactured by “TOSHIBA COMPONENTS.”

Explanation of Lot No.



Month of manufacture: January to December are denoted by letters A to L respectively.
Year of manufacture: Last decimal digit of the year of manufacture

RESTRICTIONS ON PRODUCT USE

20070701-EN GENERAL

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